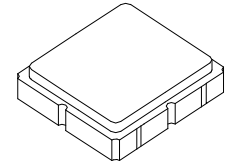




SF2002E

**942.5 MHz
SAW Filter**

- **RF Filter for EGSM**
- **Low Loss Design**
- **No Matching Circuit Required**
- **3.0 x 3.0 x 1.3 mm Package**
- **Complies with Directive 2002/95/EC (RoHS)**



SM3030-6

Absolute Maximum Ratings

Rating	Value	Units
Maximum Input Power	+15	dBm
DC voltage between Terminals	-5 ~ +5	VDC
Operating Temperature	-30 to +85	°C

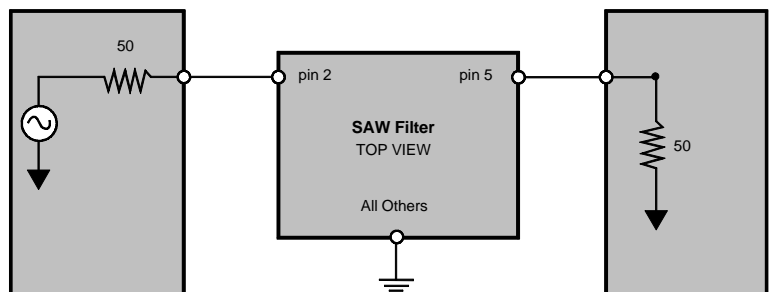
Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Operating Frequency	f_c			947.5		MHz
Passband	Insertion Loss (925~960 MHz)	IL		2.2	3.0	dB
	Amplitude Ripple (925~960 MHz)			0.8	1.5	dB
Attenuation	D.C.~905 MHz		17.0	20.5		dB
	905~915 MHz		5.0	15.0		dB
	980~1000 MHz		13.0	30.0		dB
	1000~2000 MHz		20.0	23.0		dB
VSWR (925~960 MHz)			2.2		2.7	dB
Input Z_{IN}		1		50		Ω
Output Z_{OUT}		1		50		Ω

Case Style	SM3030-6 3 x 3 mm Nominal Footprint
Lid Symbolization (YY=year, WW=week, D=day)	597 YYWWD

Electrical Connections

Connection	Terminals
Input	2
Output	5
Ground	All others



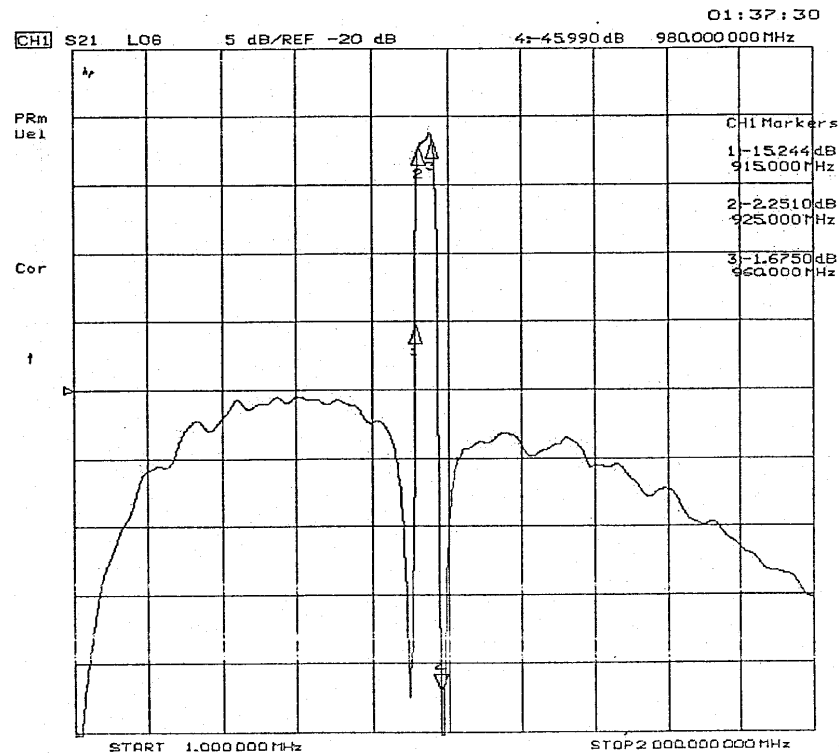
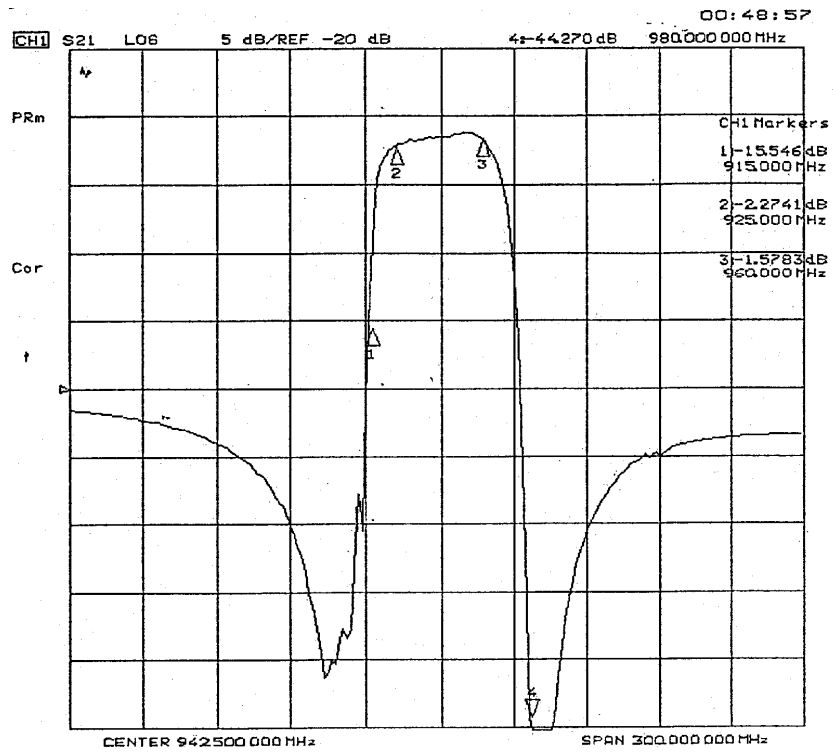
Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_c .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
9. ©Copyright 1999, RF Monolithics Inc.
10. Electrostatic Sensitive Device. Observe precautions for handling.

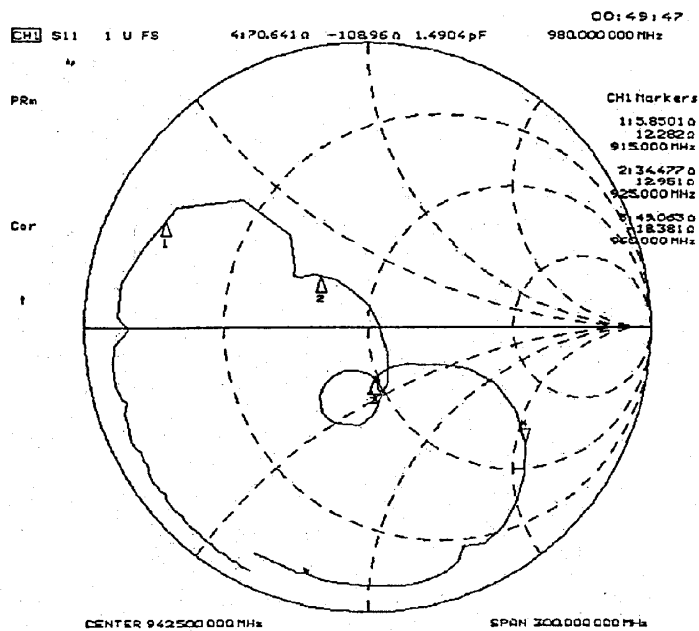
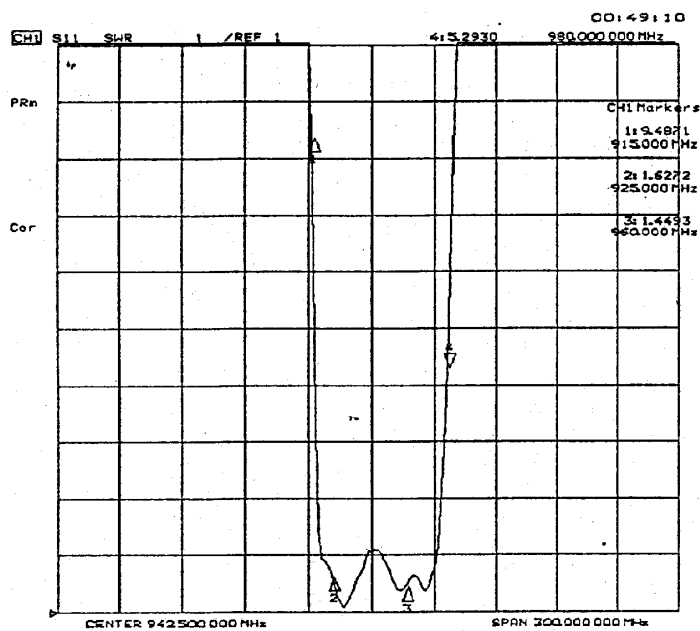


FREQUENCY CHARACTERISTICS:

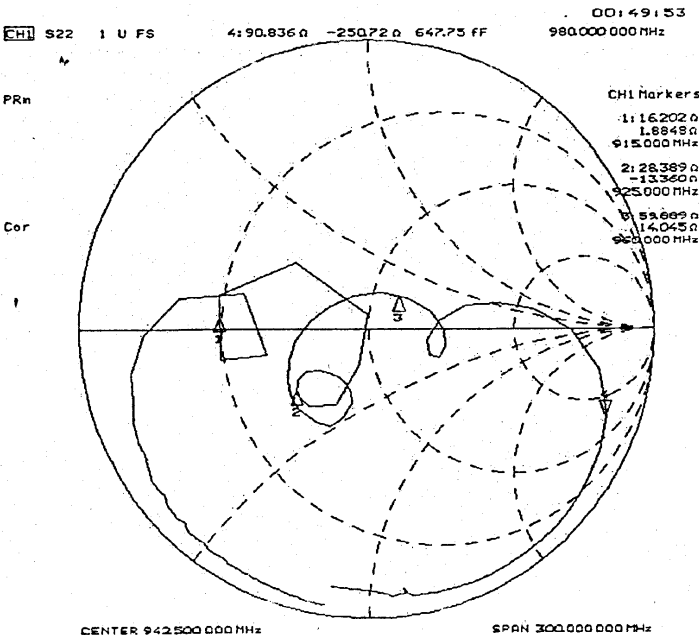
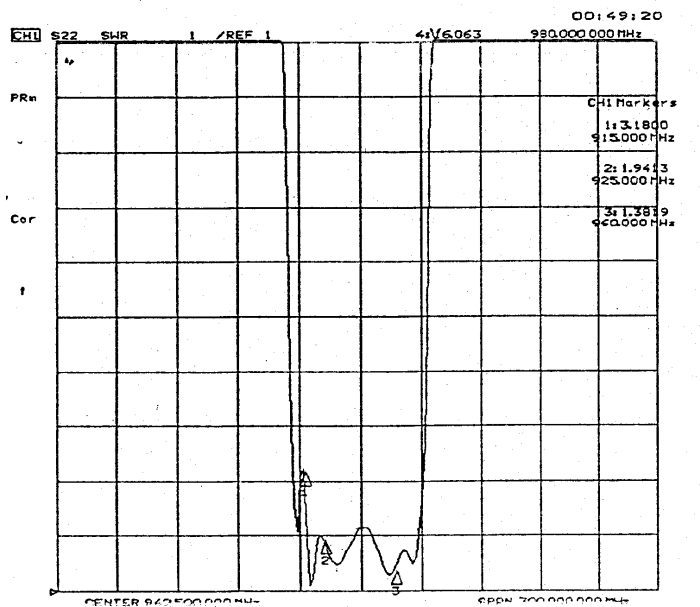
1. wideband response:



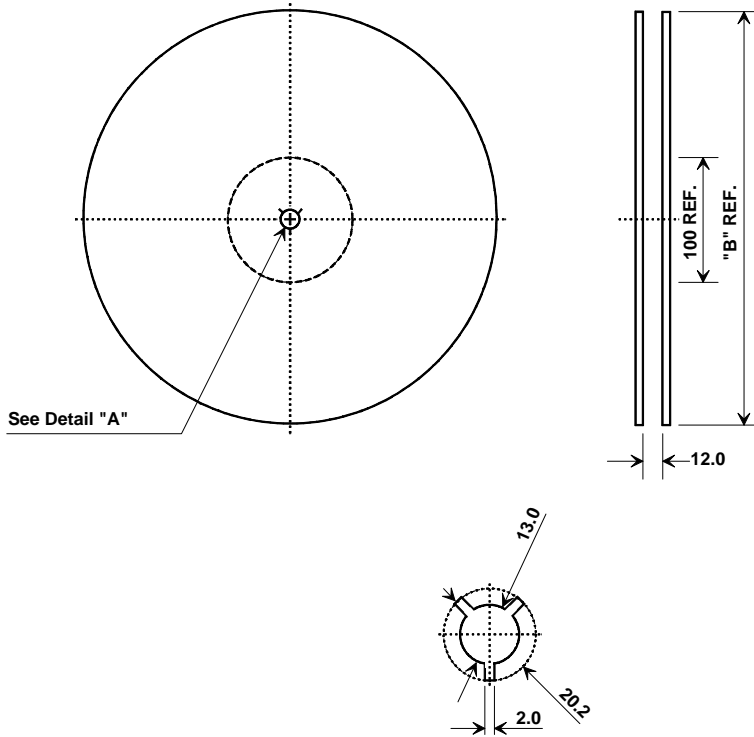
S11 Return Loss & VSWR:



S22 Return Loss & VSWR:

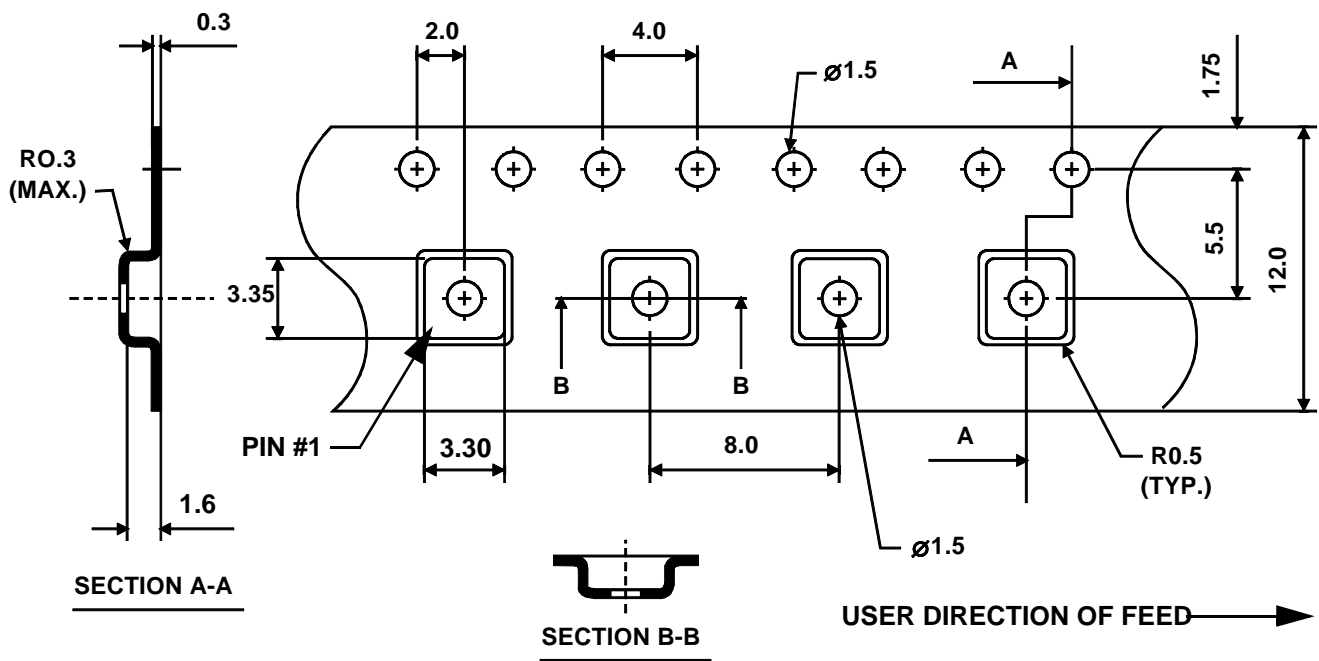


Tape and Reel Specifications



"B "		Quantity Per Reel
Nominal Size		
Inches	millimeters	
7	178	500
13	330	3000

COMPONENT ORIENTATION

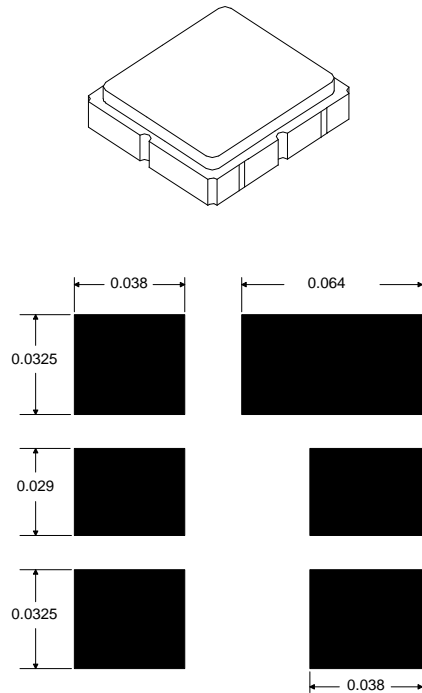


SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case
3.0 X 3.0 mm Nominal Footprint

Case Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.0	3.13	0.113	0.118	0.123
B	2.87	3.0	3.13	0.113	0.118	0.123
C	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.9	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.6	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.5	1.63	0.054	0.059	0.064
I	0.47	0.6	0.73	0.019	0.024	0.029
J	1.17	1.3	1.43	0.046	0.051	0.056



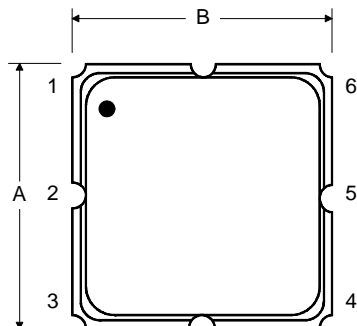
PCB Foot Print Dimensions
in Nominal Inches

Electrical Connections

Connection		Terminals
Port 1	Single Ended Input	2
Port 2	Single Ended Output	5
	Ground	All others
Single Ended Operation Only		
Dot indicates Pin 1		

Materials	
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick
Body	Al ₂ O ₃ Ceramic
Pb Free	

TOP VIEW



BOTTOM VIEW

